

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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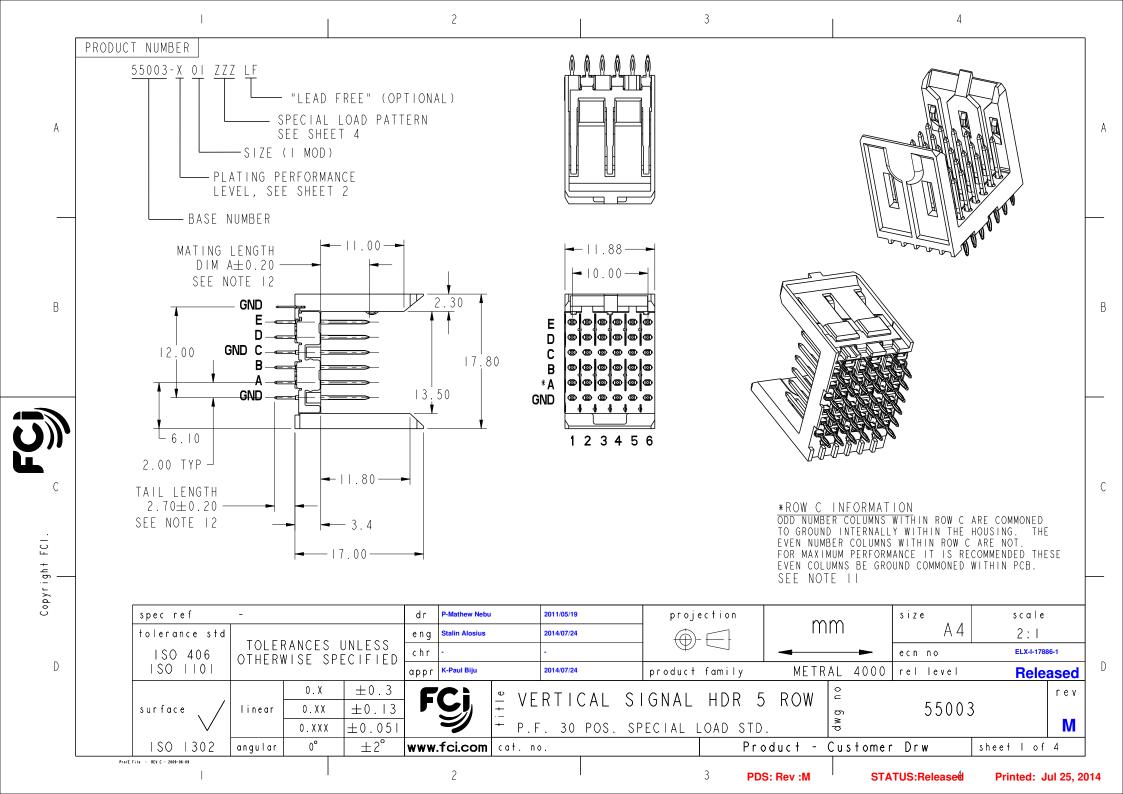
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A	PRODUCT PERFORMANCE LEVEL 55003-101ZZZ TELCORDIA CO 55003-501ZZZF TELCORDIA UE 55003-501ZZZF TELCORDIA UE 55003-901ZZZ TELCORDIA CO NOTES:	ATLON GS 20 OLA FOR	8. TEMPERAT	URE RANGE : -55°C TO +105°	C			A
	I. SEE APPLICATION SPECIFIC. INFORMATION ON AVAILABLE BOARD DESIGN CONSIDERATION PROCEDURES AND PRODUCT OF SEE PRODUCT SPECIFICATION	(O.) AVOID TR	9. P/N 55003-X01ZZZ SHOWN. (O) AVOID TRACES ON TOP OF BOARD DUE TO EXPOSED GROUND SHIELD.					
В	2. UNLESS OTHERWISE SPECIFII AND TOLERANCES ARE IN ACC ASME Y14.5, 1994 3. HOUSING MATERIAL: LIQUID 30% GLASS FILLED, FLAME I PIN MATERIAL: PHOSPHOR BI GROUND SPRING MATERIAL: I STRIPLINE SHIELD MATERIA	CORDANCE WITH CRYSTAL POLYMER, RETARDANT PER UL 94-VO. RONZE PHOSPHOR BRONZE	PINS IN GROUND. POWER, T SURROUND CAN CARR ONLY FOR "C" ROW	T PLUG-UP APPLICATIONS, TH ROW "C" CAN BE USED FOR PO IF THE SURROUNDING PINS AR HEN EACH PIN CAN CARRY 3 A ING PINS ARE USED FOR POWE Y I AMP. WHEN THE SURROUND LOW SPEED SIGNALS, THEN T PINS CAN ALSO BE USED FOR SERTION INTO, CIRCUIT BOAR	WER AS WELL AS FOR E NOT USED FOR MPS. IF THE R, THEN EACH PIN ING PINS ARE USED HE EVEN NUMBERED LOW SPEED SIGNALS.			В
ght FCI.	DIM A: 5.00mm MIN, DIM A: 5.00mm MIN, DIM A: 5.00mm MIN, FOR USE WITH METR. DIM A: 5.00mm MIN, DIM A: 5.00mm MIN, DIM A: 5.00mm MIN, 5. THE MIN PCB THICKNESS FOI APPLICATIONS IS 1.6mm. 6. THE 'CONNECTOR OUTLINE' REQUIRED. TO DETERMINE THE	AL 4000 RECEPTACLES. 6.50mm MAX FOR ROWS A,B,D 8.00mm MAX FOR ROWS C 5.75mm MAX FOR ROWS GND AL 1000 RECEPTACLES 8.00mm MAX FOR ROWS A,B,C 5.75mm MAX FOR ROW GND R FRONT PLUG-UP IS THE MIN OUTLINE HE OUTLINE NECESSARY PES OF REPAIR OPERATIONS,	EUROPEAN REGULATI ALL PROD 60 SECON REFLOW C 14 FOR LEAD EXAMPLE: 15. PLATING THE PERF PLATING IS SnPb.	FREE PART NUMBERS, ADD AN 55003-X01002LF. INFORMATION: PLATING ON CO ORMANCE LEVELS SHOWN IN TA ON "LF" TAILS IN Sn. PLATI	R COUNTRY 008. RE TO 260°C FOR RED OR VAPOR PHASE 'LF' SUFFIX. NTACT AREA MEETS BLE ON THIS SHEET. NG ON ALL OTHER TAILS			С
Copyright 	7. CURRENT RATING : I AMP P	ER PIN						
ن	spec ref - tolerance std	dr P-Mathew N		projection	mm	size A4	scale 2:1	
	TOLERANCE:	S UNLESS chs	-		←	ecn no	ELX-I-17886-1	-
D	ISO 1101 OTHERWISE	appr K-Paul Biju	2014/07/24	product family	METRAL 4000	rel level	Released	D
	surface linear 0.XX 0.XX 0.XX	x ±0.13 x ±0.051	-	. SIGNAL HDR 5	б ж р	55003	r e v	
l	100 1303 2021 00	⊥ ⊃° luuuu foi oo	mal cat no	D ~ ^	duct - Customor	a Danu Laha		1

<u>ISO</u> 1302 Pro/E File - REV C - 2009-06-09

0°

angular

±2°

www.fci.com cat. no.

PDS: Rev :M

Product - Customer Drw

STATUS:Released

Printed: Jul 25, 2014

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